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Kind regards,

Team Nexperia

# 74HC2G66; 74HCT2G66

## Dual single-pole single-throw analog switch

Rev. 10 — 3 October 2013

Product data sheet

### 1. General description

The 74HC2G66; 74HCT2G66 is a dual single pole, single-throw analog switch. Each switch has two input/output terminals (nY and nZ) and a digital enable input (nE). When nE is LOW, the analog switch is turned off. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

### 2. Features and benefits

- Wide supply voltage range from 2.0 V to 10.0 V for 74HC2G66
- Very low ON resistance:
  - ◆ 41  $\Omega$  (typ.) at  $V_{CC} = 4.5$  V
  - ◆ 30  $\Omega$  (typ.) at  $V_{CC} = 6.0$  V
  - ◆ 21  $\Omega$  (typ.) at  $V_{CC} = 9.0$  V
- High noise immunity
- Low power dissipation
- 25 mA continuous switch current
- Multiple package options
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V
- Specified from  $-40$  °C to  $+85$  °C and  $-40$  °C to  $+125$  °C

### 3. Ordering information

Table 1. Ordering information

| Type number               | Package               |        |   |          |
|---------------------------|-----------------------|--------|---|----------|
|                           | Temperature range     | Name   | Description   | Version  |
| 74HC2G66DP<br>74HCT2G66DP | $-40$ °C to $+125$ °C | TSSOP8 | plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm                 | SOT505-2 |
| 74HC2G66DC<br>74HCT2G66DC | $-40$ °C to $+125$ °C | VSSOP8 | plastic very thin shrink small outline package; 8 leads; body width 2.3 mm                              | SOT765-1 |
| 74HC2G66GT<br>74HCT2G66GT | $-40$ °C to $+125$ °C | XSON8  | plastic extremely thin small outline package; no leads; 8 terminals; body $1 \times 1.95 \times 0.5$ mm | SOT833-1 |
| 74HC2G66GD<br>74HCT2G66GD | $-40$ °C to $+125$ °C | XSON8  | plastic extremely thin small outline package; no leads; 8 terminals; body $3 \times 2 \times 0.5$ mm    | SOT996-2 |



## 4. Marking

Table 2. Marking codes

| Type number | Marking <sup>[1]</sup> |
|-------------|------------------------|
| 74HC2G66DP  | H66                    |
| 74HCT2G66DP | T66                    |
| 74HC2G66DC  | H66                    |
| 74HCT2G66DC | T66                    |
| 74HC2G66GT  | H66                    |
| 74HCT2G66GT | T66                    |
| 74HC2G66GD  | H66                    |
| 74HCT2G66GD | T66                    |

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

## 5. Functional diagram

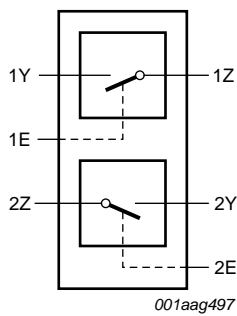


Fig 1. Logic symbol

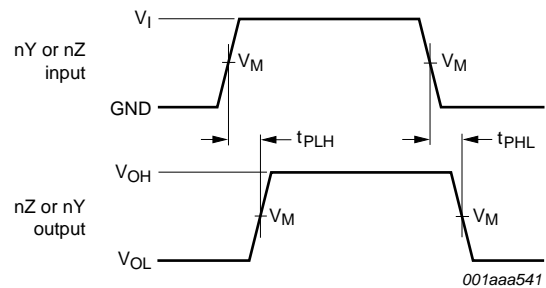
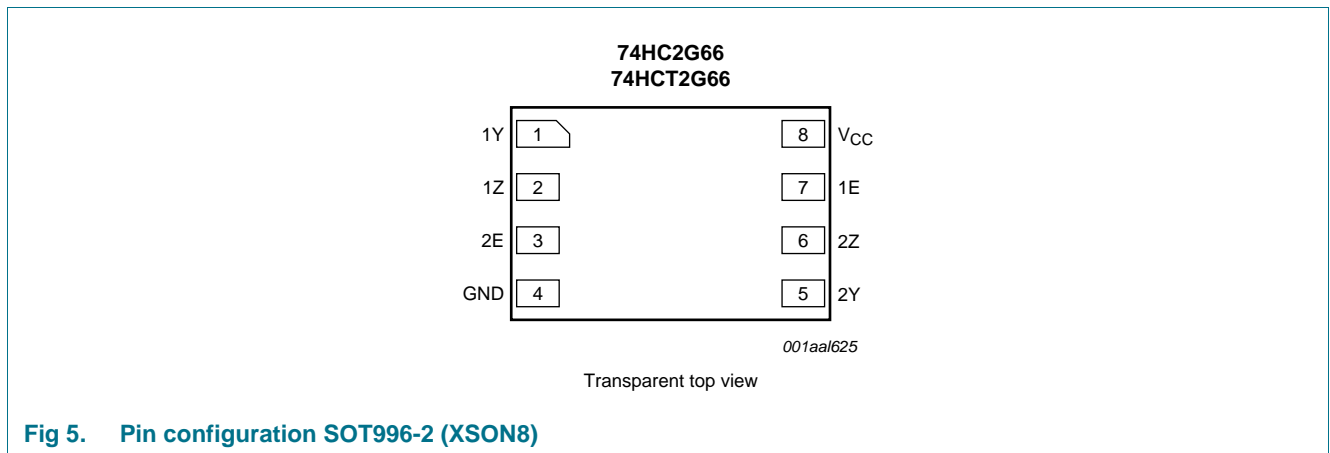
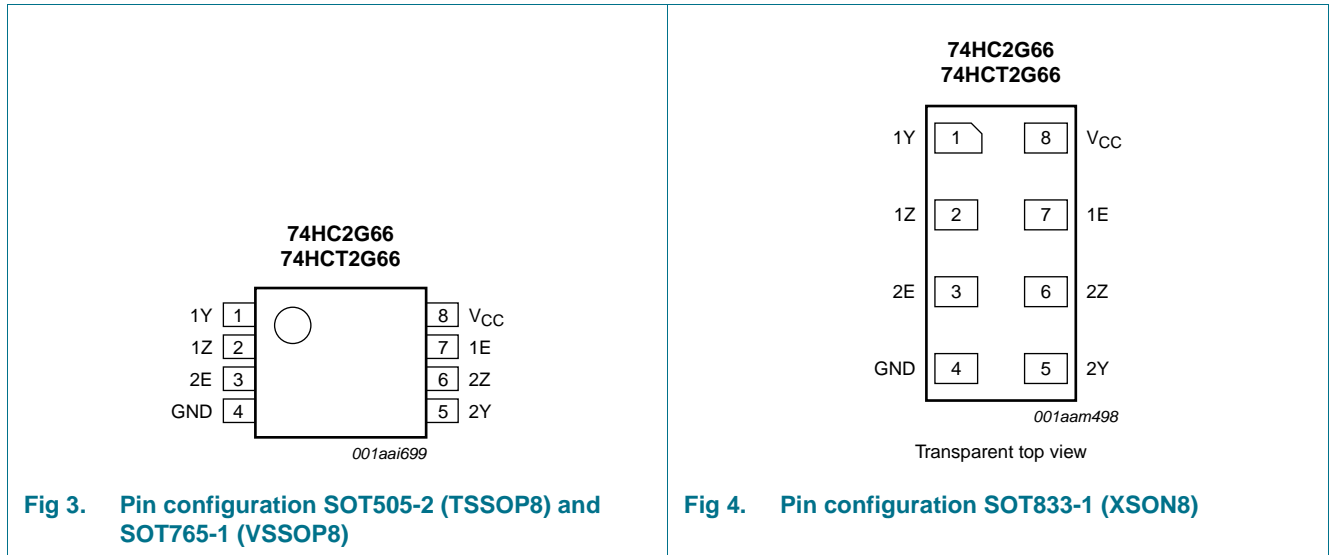


Fig 2. Logic diagram for 1 switch

## 6. Pinning information

### 6.1 Pinning



### 6.2 Pin description

**Table 3. Pin description**

| Symbol          | Pin  | Description                 |
|-----------------|------|-----------------------------|
| 1Y, 2Y          | 1, 5 | independent input or output |
| 1Z, 2Z          | 2, 6 | independent input or output |
| GND             | 4    | ground (0 V)                |
| 1E, 2E          | 7, 3 | enable input (active HIGH)  |
| V <sub>CC</sub> | 8    | supply voltage              |

## 7. Functional description

Table 4. Function table<sup>[1]</sup>

| Input nE | Switch |
|----------|--------|
| L        | OFF    |
| H        | ON     |

[1] H = HIGH voltage level; L = LOW voltage level.

## 8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions   | Min              | Max      | Unit |
|-----------|-------------------------|--|------------------|----------|------|
| $V_{CC}$  | supply voltage          |  | -0.5             | +11.0    | V    |
| $I_{IK}$  | input clamping current  | $V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$       | <sup>[1]</sup> - | $\pm 20$ | mA   |
| $I_{SK}$  | switch clamping current | $V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$       | <sup>[1]</sup> - | $\pm 20$ | mA   |
| $I_{SW}$  | switch current          | $V_{SW} > -0.5\text{ V}$ or $V_{SW} < V_{CC} + 0.5\text{ V}$ | -                | $\pm 20$ | mA   |
| $I_{CC}$  | supply current          |  | -                | 30       | mA   |
| $I_{GND}$ | ground current          |  | -30              | -        | mA   |
| $T_{stg}$ | storage temperature     |  | -65              | +150     | °C   |
| $P_{tot}$ | total power dissipation | $T_{amb} = -40\text{ °C}$ to $+125\text{ °C}$                |                  |          |      |
|           |                         | per package  | <sup>[2]</sup> - | 300      | mW   |
|           |                         | per switch   | <sup>[2]</sup> - | 100      | mW   |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP8 packages: above 55 °C the value of  $P_{tot}$  derates linearly with 2.5 mW/K.  
 For VSSOP8 packages: above 110 °C the value of  $P_{tot}$  derates linearly with 8.0 mW/K.  
 For XSON8 packages: above 118 °C the value of  $P_{tot}$  derates linearly with 7.8 mW/K.

## 9. Recommended operating conditions

**Table 6. Recommended operating conditions**

Voltages are referenced to GND (ground = 0 V).<sup>[1]</sup>

| Symbol           | Parameter                           | Conditions               | 74HC2G66 |      |                 | 74HCT2G66 |      |                 | Unit |
|------------------|-------------------------------------|--------------------------|----------|------|-----------------|-----------|------|-----------------|------|
|                  |                                     |                          | Min      | Typ  | Max             | Min       | Typ  | Max             |      |
| V <sub>CC</sub>  | supply voltage                      |                          | 2.0      | 5.0  | 10.0            | 4.5       | 5.0  | 5.5             | V    |
| V <sub>I</sub>   | input voltage                       |                          | 0        | -    | V <sub>CC</sub> | 0         | -    | V <sub>CC</sub> | V    |
| V <sub>O</sub>   | output voltage                      |                          | 0        | -    | V <sub>CC</sub> | 0         | -    | V <sub>CC</sub> | V    |
| V <sub>SW</sub>  | switch voltage                      |                          | 0        | -    | V <sub>CC</sub> | 0         | -    | V <sub>CC</sub> | V    |
| T <sub>amb</sub> | ambient temperature                 |                          | -40      | +25  | +125            | -40       | +25  | +125            | °C   |
| Δt/ΔV            | input transition rise and fall rate | V <sub>CC</sub> = 2.0 V  | -        | -    | 625             | -         | -    | -               | ns/V |
|                  |                                     | V <sub>CC</sub> = 4.5 V  | -        | 1.67 | 139             | -         | 1.67 | 139             | ns/V |
|                  |                                     | V <sub>CC</sub> = 6.0 V  | -        | -    | 83              | -         | -    | -               | ns/V |
|                  |                                     | V <sub>CC</sub> = 10.0 V | -        | -    | 35              | -         | -    | -               | ns/V |

[1] To avoid drawing V<sub>CC</sub> current out of pin nZ, when switch current flows in pin nY, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into pin nZ, no V<sub>CC</sub> current will flow out of terminal nY. In this case there is no limit for the voltage drop across the switch, but the voltage at pins nY and nZ may not exceed V<sub>CC</sub> or GND.

## 10. Static characteristics

**Table 7. Static characteristics**

Voltages are referenced to GND (ground = 0 V).

| Symbol              | Parameter                 | Conditions  | -40 °C to +85 °C |                    |      | -40 °C to +125 °C |      | Unit |
|---------------------|---------------------------|---|------------------|--------------------|------|-------------------|------|------|
|                     |                           |   | Min              | Typ <sup>[1]</sup> | Max  | Min               | Max  |      |
| <b>74HC2G66</b>     |                           |   |                  |                    |      |                   |      |      |
| V <sub>IH</sub>     | HIGH-level input voltage  | V <sub>CC</sub> = 2.0 V   | 1.5              | 1.2                | -    | 1.5               | -    | V    |
|                     |                           | V <sub>CC</sub> = 4.5 V   | 3.15             | 2.4                | -    | 3.15              | -    | V    |
|                     |                           | V <sub>CC</sub> = 6.0 V   | 4.2              | 3.2                | -    | 4.2               | -    | V    |
|                     |                           | V <sub>CC</sub> = 9.0 V   | 6.3              | 4.7                | -    | 6.3               | -    | V    |
| V <sub>IL</sub>     | LOW-level input voltage   | V <sub>CC</sub> = 2.0 V   | -                | 0.8                | 0.5  | -                 | 0.5  | V    |
|                     |                           | V <sub>CC</sub> = 4.5 V   | -                | 2.1                | 1.35 | -                 | 1.35 | V    |
|                     |                           | V <sub>CC</sub> = 6.0 V   | -                | 2.8                | 1.8  | -                 | 1.8  | V    |
|                     |                           | V <sub>CC</sub> = 9.0 V   | -                | 4.3                | 2.7  | -                 | 2.7  | V    |
| I <sub>I</sub>      | input leakage current     | nE; V <sub>I</sub> = V <sub>CC</sub> or GND                     |                  |                    |      |                   |      |      |
|                     |                           | V <sub>CC</sub> = 6.0 V   | -                | -                  | ±0.1 | -                 | ±0.1 | μA   |
|                     |                           | V <sub>CC</sub> = 9.0 V   | -                | -                  | ±0.2 | -                 | ±0.2 | μA   |
| I <sub>S(OFF)</sub> | OFF-state leakage current | nY or nZ; V <sub>CC</sub> = 9.0 V; see <a href="#">Figure 6</a> | -                | 0.1                | 1.0  | -                 | 1.0  | μA   |
| I <sub>S(ON)</sub>  | ON-state leakage current  | nY or nZ; V <sub>CC</sub> = 9.0 V; see <a href="#">Figure 7</a> | -                | 0.1                | 1.0  | -                 | 1.0  | μA   |
| I <sub>CC</sub>     | supply current            | nE, nY and nZ = V <sub>CC</sub> or GND                          |                  |                    |      |                   |      |      |
|                     |                           | V <sub>CC</sub> = 6.0 V   | -                | -                  | 10   | -                 | 20   | μA   |
|                     |                           | V <sub>CC</sub> = 9.0 V   | -                | -                  | 20   | -                 | 40   | μA   |

**Table 7. Static characteristics ...continued**  
 Voltages are referenced to GND (ground = 0 V).

| Symbol              | Parameter                     | Conditions  | -40 °C to +85 °C |                    |      | -40 °C to +125 °C |      | Unit |
|---------------------|-------------------------------|---|------------------|--------------------|------|-------------------|------|------|
|                     |                               |   | Min              | Typ <sup>[1]</sup> | Max  | Min               | Max  |      |
| C <sub>I</sub>      | input capacitance             |   | -                | 3.5                | -    | -                 | -    | pF   |
| C <sub>PD</sub>     | power dissipation capacitance |   | -                | 9                  | -    | -                 | -    | pF   |
| C <sub>S(ON)</sub>  | ON-state capacitance          |   | -                | 8                  | -    | -                 | -    | pF   |
| <b>74HCT2G66</b>    |                               |   |                  |                    |      |                   |      |      |
| V <sub>IH</sub>     | HIGH-level input voltage      | V <sub>CC</sub> = 4.5 V to 5.5 V  | 2.0              | 1.6                | -    | 2.0               | -    | V    |
| V <sub>IL</sub>     | LOW-level input voltage       | V <sub>CC</sub> = 4.5 V to 5.5 V  | -                | 1.2                | 0.8  | -                 | 0.8  | V    |
| I <sub>I</sub>      | input leakage current         | nE; V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 5.5 V                  | -                | -                  | ±1.0 | -                 | ±1.0 | μA   |
| I <sub>S(OFF)</sub> | OFF-state leakage current     | nY or nZ; V <sub>CC</sub> = 5.5 V; see <a href="#">Figure 6</a>                       | -                | 0.1                | 1.0  | -                 | 1.0  | μA   |
| I <sub>S(ON)</sub>  | ON-state leakage current      | nY or nZ; V <sub>CC</sub> = 5.5 V; see <a href="#">Figure 7</a>                       | -                | 0.1                | 1.0  | -                 | 1.0  | μA   |
| I <sub>CC</sub>     | supply current                | nE, nY and nZ = V <sub>CC</sub> or GND; V <sub>CC</sub> = 4.5 V to 5.5 V              | -                | -                  | 10   | -                 | 20   | μA   |
| ΔI <sub>CC</sub>    | additional supply current     | nE = V <sub>CC</sub> - 2.1 V; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 4.5 V to 5.5 V; | -                | -                  | 375  | -                 | 410  | μA   |
| C <sub>I</sub>      | input capacitance             |   | -                | 3.5                | -    | -                 | -    | pF   |
| C <sub>PD</sub>     | power dissipation capacitance |   | -                | 9                  | -    | -                 | -    | pF   |
| C <sub>S(ON)</sub>  | ON-state capacitance          |   | -                | 8                  | -    | -                 | -    | pF   |

[1] Typical values are measured at T<sub>amb</sub> = 25 °C.

**10.1 Test circuits**

001aaJ465

V<sub>I</sub> = V<sub>CC</sub> or GND and V<sub>O</sub> = GND or V<sub>CC</sub>.

**Fig 6. Test circuit for measuring OFF-state leakage current**

001aaJ466

V<sub>I</sub> = V<sub>CC</sub> or GND and V<sub>O</sub> = open circuit.

**Fig 7. Test circuit for measuring ON-state leakage current**

## 10.2 ON resistance

**Table 8. ON resistance for 74HC2G66 and 74HCT2G66**

At recommended operating conditions; voltages are referenced to GND (ground 0 V); for graph see [Figure 9](#).

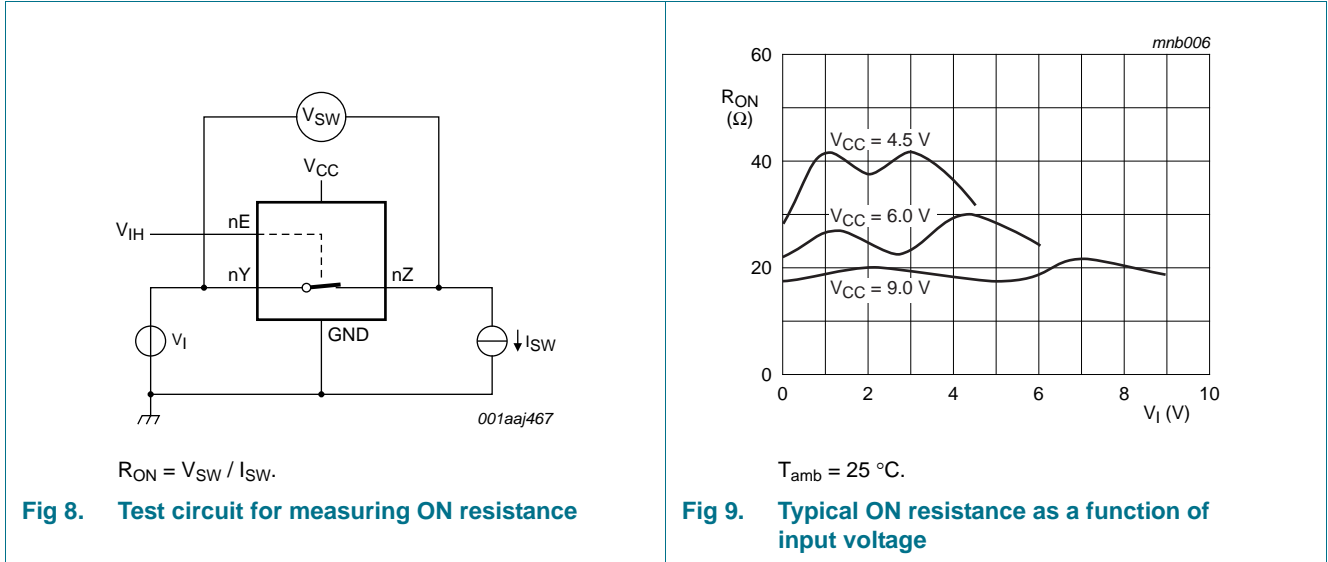
| Symbol                        | Parameter                               | Conditions   | -40 °C to +85 °C |                    |     | -40 °C to +125 °C |     | Unit |
|-------------------------------|---|--|------------------|--------------------|-----|-------------------|-----|------|
|                               |   |  | Min              | Typ <sup>[2]</sup> | Max | Min               | Max |      |
| <b>74HC2G66<sup>[1]</sup></b> |   |  |                  |                    |     |                   |     |      |
| R <sub>ON(peak)</sub>         | ON resistance (peak)                    | V <sub>I</sub> = GND to V <sub>CC</sub> ; see <a href="#">Figure 8</a> and <a href="#">9</a> |                  |                    |     |                   |     |      |
|                               |   | I <sub>SW</sub> = 0.1 mA; V <sub>CC</sub> = 2.0 V  | -                | 250                | -   | -                 | -   | Ω    |
|                               |   | I <sub>SW</sub> = 1.0 mA; V <sub>CC</sub> = 4.5 V  | -                | 41                 | 118 | -                 | 142 | Ω    |
|                               |   | I <sub>SW</sub> = 1.0 mA; V <sub>CC</sub> = 6.0 V  | -                | 30                 | 105 | -                 | 126 | Ω    |
|                               |   | I <sub>SW</sub> = 1.0 mA; V <sub>CC</sub> = 9.0 V  | -                | 21                 | 88  | -                 | 105 | Ω    |
| R <sub>ON(rail)</sub>         | ON resistance (rail)                    | V <sub>I</sub> = GND; see <a href="#">Figure 8</a> and <a href="#">9</a>                     |                  |                    |     |                   |     |      |
|                               |   | I <sub>SW</sub> = 0.1 mA; V <sub>CC</sub> = 2.0 V  | -                | 65                 | -   | -                 | -   | Ω    |
|                               |   | I <sub>SW</sub> = 1.0 mA; V <sub>CC</sub> = 4.5 V  | -                | 28                 | 95  | -                 | 115 | Ω    |
|                               |   | I <sub>SW</sub> = 1.0 mA; V <sub>CC</sub> = 6.0 V  | -                | 22                 | 82  | -                 | 100 | Ω    |
|                               |   | I <sub>SW</sub> = 1.0 mA; V <sub>CC</sub> = 9.0 V  | -                | 18                 | 70  | -                 | 80  | Ω    |
|                               |   | V <sub>I</sub> = V <sub>CC</sub> ; see <a href="#">Figure 8</a> and <a href="#">9</a>        |                  |                    |     |                   |     |      |
|                               |   | I <sub>SW</sub> = 0.1 mA; V <sub>CC</sub> = 2.0 V  | -                | 65                 | -   | -                 | -   | Ω    |
|                               |   | I <sub>SW</sub> = 1.0 mA; V <sub>CC</sub> = 4.5 V  | -                | 31                 | 106 | -                 | 128 | Ω    |
|                               |   | I <sub>SW</sub> = 1.0 mA; V <sub>CC</sub> = 6.0 V  | -                | 23                 | 94  | -                 | 113 | Ω    |
|                               |   | I <sub>SW</sub> = 1.0 mA; V <sub>CC</sub> = 9.0 V  | -                | 19                 | 78  | -                 | 95  | Ω    |
| ΔR <sub>ON</sub>              | ON resistance mismatch between channels | V <sub>I</sub> = V <sub>CC</sub> to GND; see <a href="#">Figure 8</a> and <a href="#">9</a>  |                  |                    |     |                   |     |      |
|                               |   | V <sub>CC</sub> = 4.5 V  | -                | 5                  | -   | -                 | -   | Ω    |
|                               |   | V <sub>CC</sub> = 6.0 V  | -                | 4                  | -   | -                 | -   | Ω    |
|                               |   | V <sub>CC</sub> = 9.0 V  | -                | 3                  | -   | -                 | -   | Ω    |
| <b>74HCT2G66</b>              |   |  |                  |                    |     |                   |     |      |
| R <sub>ON(peak)</sub>         | ON resistance (peak)                    | V <sub>I</sub> = GND to V <sub>CC</sub> ; see <a href="#">Figure 8</a> and <a href="#">9</a> |                  |                    |     |                   |     |      |
|                               |   | I <sub>SW</sub> = 1.0 mA; V <sub>CC</sub> = 4.5 V  | -                | 41                 | 118 | -                 | 142 | Ω    |
| R <sub>ON(rail)</sub>         | ON resistance (rail)                    | V <sub>I</sub> = GND; see <a href="#">Figure 8</a> and <a href="#">9</a>                     |                  |                    |     |                   |     |      |
|                               |   | I <sub>SW</sub> = 1.0 mA; V <sub>CC</sub> = 4.5 V  | -                | 28                 | 95  | -                 | 115 | Ω    |
|                               |   | V <sub>I</sub> = V <sub>CC</sub> ; see <a href="#">Figure 8</a> and <a href="#">9</a>        |                  |                    |     |                   |     |      |
|                               |   | I <sub>SW</sub> = 1.0 mA; V <sub>CC</sub> = 4.5 V  | -                | 31                 | 106 | -                 | 128 | Ω    |
| ΔR <sub>ON</sub>              | ON resistance mismatch between channels | V <sub>I</sub> = V <sub>CC</sub> to GND; see <a href="#">Figure 8</a> and <a href="#">9</a>  |                  |                    |     |                   |     |      |
|                               |   | V <sub>CC</sub> = 4.5 V  | -                | 5                  | -   | -                 | -   | Ω    |

[1] At supply voltages approaching 2 V, the ON resistance becomes extremely non-linear. Therefore it is recommended that these devices be used to transmit digital signals only, when using this supply voltage.

[2] Typical values are measured at T<sub>amb</sub> = 25 °C.



10.3 ON resistance test circuit and graphs



11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); For test circuit see Figure 12.

| Symbol          | Parameter                     | Conditions  | -40 °C to +85 °C |                    |     | -40 °C to +125 °C |     | Unit |  |
|-----------------|-------------------------------|---|------------------|--------------------|-----|-------------------|-----|------|--|
|                 |                               |   | Min              | Typ <sup>[1]</sup> | Max | Min               | Max |      |  |
| <b>74HC2G66</b> |                               |   |                  |                    |     |                   |     |      |  |
| $t_{pd}$        | propagation delay             | nY to nZ or nZ to nY; $R_L = \infty \Omega$ ; see Figure 10 |                  | [2]                |     |                   |     |      |  |
|                 |                               | $V_{CC} = 2.0\text{ V}$                                     | -                | 6.5                | 65  | -                 | 80  | ns   |  |
|                 |                               | $V_{CC} = 4.5\text{ V}$                                     | -                | 2                  | 13  | -                 | 15  | ns   |  |
|                 |                               | $V_{CC} = 6.0\text{ V}$                                     | -                | 1.5                | 11  | -                 | 14  | ns   |  |
|                 |                               | $V_{CC} = 9.0\text{ V}$                                     | -                | 1.2                | 10  | -                 | 12  | ns   |  |
| $t_{en}$        | enable time                   | nE to nY or nZ; see Figure 11                               |                  | [2]                |     |                   |     |      |  |
|                 |                               | $V_{CC} = 2.0\text{ V}$                                     | -                | 40                 | 125 | -                 | 150 | ns   |  |
|                 |                               | $V_{CC} = 4.5\text{ V}$                                     | -                | 12                 | 29  | -                 | 30  | ns   |  |
|                 |                               | $V_{CC} = 6.0\text{ V}$                                     | -                | 10                 | 21  | -                 | 26  | ns   |  |
|                 |                               | $V_{CC} = 9.0\text{ V}$                                     | -                | 7                  | 16  | -                 | 20  | ns   |  |
| $t_{dis}$       | disable time                  | nE to nY or nZ; see Figure 11                               |                  | [2]                |     |                   |     |      |  |
|                 |                               | $V_{CC} = 2.0\text{ V}$                                     | -                | 21                 | 145 | -                 | 175 | ns   |  |
|                 |                               | $V_{CC} = 4.5\text{ V}$                                     | -                | 12                 | 29  | -                 | 35  | ns   |  |
|                 |                               | $V_{CC} = 6.0\text{ V}$                                     | -                | 11                 | 28  | -                 | 33  | ns   |  |
|                 |                               | $V_{CC} = 9.0\text{ V}$                                     | -                | 10                 | 23  | -                 | 27  | ns   |  |
| $C_{PD}$        | power dissipation capacitance | $V_I = \text{GND to } V_{CC}$                               |                  | [3]                |     |                   |     |      |  |
|                 |                               |   | -                | 9                  | -   | -                 | -   | pF   |  |

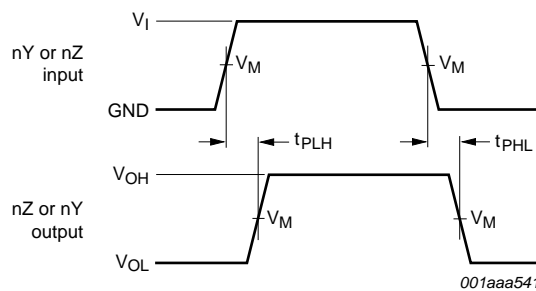
**Table 9. Dynamic characteristics ...continued**

Voltages are referenced to GND (ground = 0 V); For test circuit see [Figure 12](#).

| Symbol           | Parameter                     | Conditions  | -40 °C to +85 °C |                    |     | -40 °C to +125 °C |     | Unit |
|------------------|-------------------------------|---|------------------|--------------------|-----|-------------------|-----|------|
|                  |                               |   | Min              | Typ <sup>[1]</sup> | Max | Min               | Max |      |
| <b>74HCT2G66</b> |                               |   |                  |                    |     |                   |     |      |
| $t_{pd}$         | propagation delay             | nY to nZ or nZ to nY; $R_L = \infty \Omega$ ; see <a href="#">Figure 10</a> |                  |                    |     |                   |     |      |
|                  |                               | $V_{CC} = 4.5 V$  | -                | 2                  | 15  | -                 | 18  | ns   |
| $t_{en}$         | enable time                   | nE to nY or nZ; see <a href="#">Figure 11</a>                               |                  |                    |     |                   |     |      |
|                  |                               | $V_{CC} = 4.5 V$  | -                | 13                 | 30  | -                 | 36  | ns   |
| $t_{dis}$        | disable time                  | nE to nY or nZ; see <a href="#">Figure 11</a>                               |                  |                    |     |                   |     |      |
|                  |                               | $V_{CC} = 4.5 V$  | -                | 13                 | 44  | -                 | 53  | ns   |
| $C_{PD}$         | power dissipation capacitance | $V_I = GND$ to $V_{CC} - 1.5 V$   |                  |                    |     |                   |     | pF   |

- [1] All typical values are measured at  $T_{amb} = 25 \text{ }^\circ\text{C}$ .
- [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .  
 $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .  
 $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .
- [3]  $C_{PD}$  is used to determine the dynamic power dissipation  $P_D$  ( $\mu\text{W}$ ).  
 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma((C_L \times C_{SW}) \times V_{CC}^2 \times f_o)$  where:  
 $f_i$  = input frequency in MHz;  
 $f_o$  = output frequency in MHz;  
 $C_L$  = output load capacitance in pF;  
 $C_{SW}$  = maximum switch capacitance in pF (see [Table 7](#));  
 $V_{CC}$  = supply voltage in volts;  
 $\Sigma((C_L \times C_{SW}) \times V_{CC}^2 \times f_o)$  = sum of outputs.

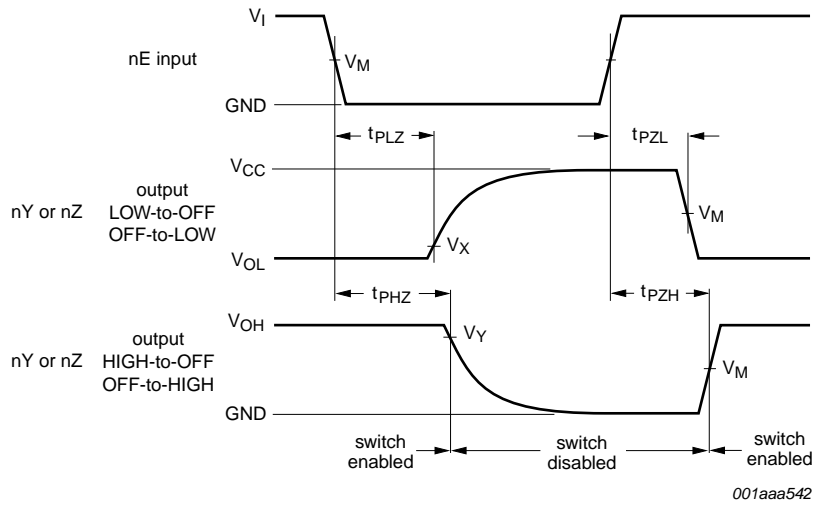
**11.1 Waveforms and test circuit**



Measurement points are given in [Table 10](#).

Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 10. Input (nY or nZ) to output (nZ or nY) propagation delays**



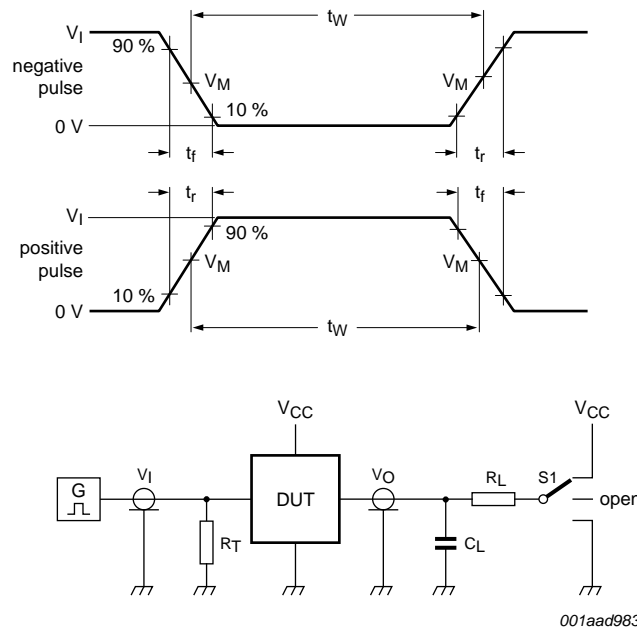
Measurement points are given in [Table 10](#).

Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 11. Enable and disable times**

**Table 10. Measurement points**

| Type      | Input       | Output      |                 |                 |
|-----------|-------------|-------------|-----------------|-----------------|
|           | $V_M$       | $V_M$       | $V_X$           | $V_Y$           |
| 74HC2G66  | $0.5V_{CC}$ | $0.5V_{CC}$ | $V_{OL} + 10\%$ | $V_{OH} - 10\%$ |
| 74HCT2G66 | 1.3 V       | 1.3 V       | $V_{OL} + 10\%$ | $V_{OH} - 10\%$ |



Test data is given in [Table 11](#).

Definitions for test circuit:

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_L$  = Load resistance.

S1 = Test selection switch.

Fig 12. Test circuit for measuring switching times

Table 11. Test data

| Type      | Input           |                | Load  |              | S1 position        |                    |                    |
|-----------|-----------------|----------------|-------|--------------|--------------------|--------------------|--------------------|
|           | $V_I$           | $t_r, t_f$ [1] | $C_L$ | $R_L$        | $t_{PHL}, t_{PLH}$ | $t_{PZH}, t_{PHZ}$ | $t_{PZL}, t_{PLZ}$ |
| 74HC2G66  | GND to $V_{CC}$ | 6 ns           | 50 pF | 1 k $\Omega$ | open               | GND                | $V_{CC}$           |
| 74HCT2G66 | GND to 3 V      | 6 ns           | 50 pF | 1 k $\Omega$ | open               | GND                | $V_{CC}$           |

[1] There is no constraint on  $t_r, t_f$  with a 50 % duty factor when measuring  $f_{max}$ .

## 11.2 Additional dynamic characteristics

Table 12. Additional dynamic characteristics for 74HC2G66 and 74HCT2G66

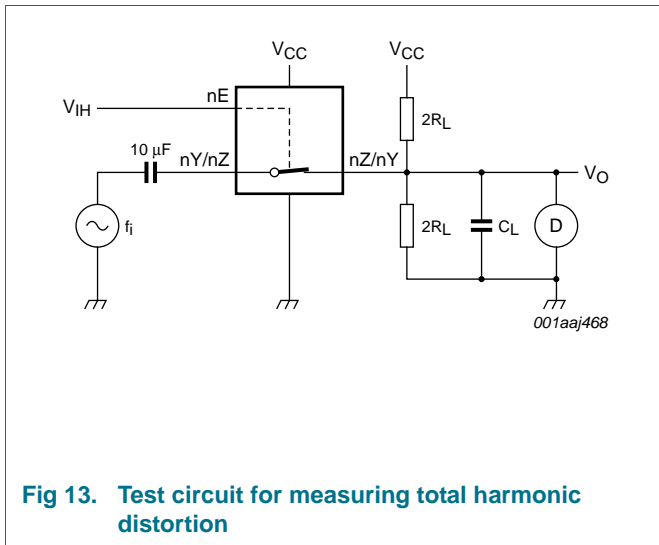
$GND = 0 V$ ;  $t_r = t_f = 6.0 ns$ ;  $C_L = 50 pF$ ; unless otherwise specified. All typical values are measured at  $T_{amb} = 25 \text{ }^\circ\text{C}$ .

| Symbol | Parameter                 | Conditions  | Min | Typ  | Max | Unit |  |
|--------|---------------------------|---|-----|------|-----|------|--|
| THD    | total harmonic distortion | $f_i = 1 \text{ kHz}$ ; $R_L = 10 \text{ k}\Omega$ ; see <a href="#">Figure 13</a>  |     |      |     | %    |  |
|        |                           | $V_{CC} = 4.5 \text{ V}$ ; $V_I = 4.0 \text{ V (p-p)}$                              | -   | 0.04 | -   | %    |  |
|        |                           | $V_{CC} = 9.0 \text{ V}$ ; $V_I = 8.0 \text{ V (p-p)}$                              | -   | 0.02 | -   | %    |  |
|        |                           | $f_i = 10 \text{ kHz}$ ; $R_L = 10 \text{ k}\Omega$ ; see <a href="#">Figure 13</a> |     |      |     |      |  |
|        |                           | $V_{CC} = 4.5 \text{ V}$ ; $V_I = 4.0 \text{ V (p-p)}$                              | -   | 0.12 | -   | %    |  |
|        |                           | $V_{CC} = 9.0 \text{ V}$ ; $V_I = 8.0 \text{ V (p-p)}$                              | -   | 0.06 | -   | %    |  |

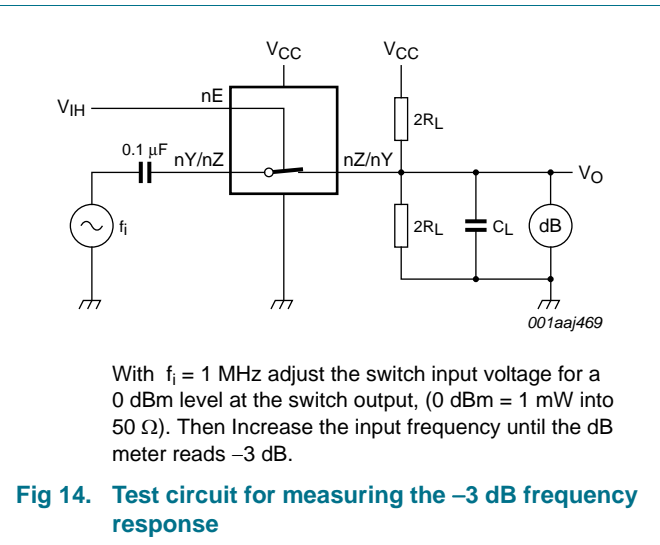
**Table 12. Additional dynamic characteristics for 74HC2G66 and 74HCT2G66 ...continued**  
*GND = 0 V;  $t_r = t_f = 6.0$  ns;  $C_L = 50$  pF; unless otherwise specified. All typical values are measured at  $T_{amb} = 25$  °C.*

| Symbol         | Parameter                | Conditions   | Min | Typ | Max | Unit |
|----------------|--------------------------|--|-----|-----|-----|------|
| $f_{(-3dB)}$   | -3 dB frequency response | $R_L = 50 \Omega$ ; $C_L = 10$ pF; see <a href="#">Figure 14</a> and <a href="#">15</a>                                  |     |     |     |      |
|                |                          | $V_{CC} = 4.5$ V   | -   | 180 | -   | MHz  |
|                |                          | $V_{CC} = 9.0$ V   | -   | 200 | -   | MHz  |
| $\alpha_{iso}$ | isolation (OFF-state)    | $R_L = 600 \Omega$ ; $f_i = 1$ MHz; see <a href="#">Figure 16</a> and <a href="#">17</a>                                 |     |     |     |      |
|                |                          | $V_{CC} = 4.5$ V   | -   | -50 | -   | dB   |
|                |                          | $V_{CC} = 9.0$ V   | -   | -50 | -   | dB   |
| $V_{ct}$       | crosstalk voltage        | between digital input and switch (peak to peak value); $R_L = 600 \Omega$ ; $f_i = 1$ MHz; see <a href="#">Figure 18</a> |     |     |     |      |
|                |                          | $V_{CC} = 4.5$ V   | -   | 110 | -   | mV   |
|                |                          | $V_{CC} = 9.0$ V   | -   | 220 | -   | mV   |
| Xtalk          | crosstalk                | between switches; $R_L = 600 \Omega$ ; $f_i = 1$ MHz; see <a href="#">Figure 19</a>                                      |     |     |     |      |
|                |                          | $V_{CC} = 4.5$ V   | -   | -60 | -   | dB   |
|                |                          | $V_{CC} = 9.0$ V   | -   | -60 | -   | dB   |

11.3 Test circuits and graphs

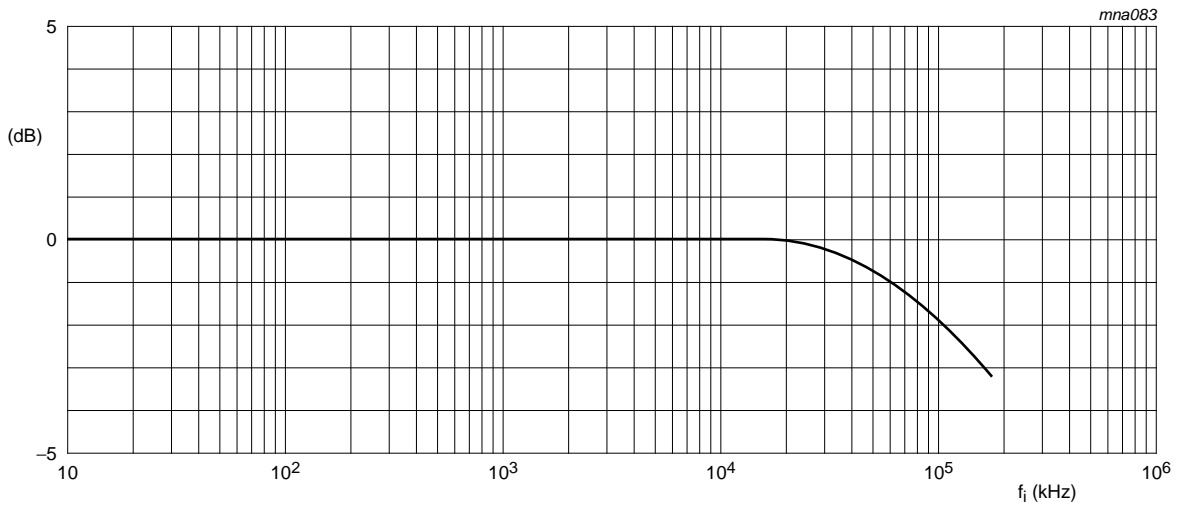


**Fig 13. Test circuit for measuring total harmonic distortion**



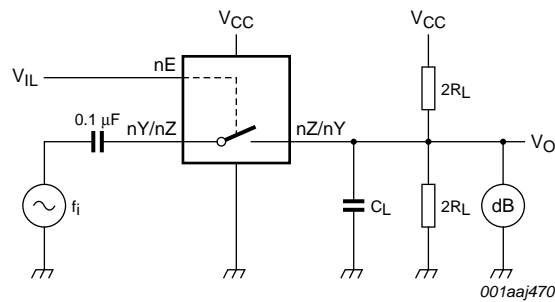
**Fig 14. Test circuit for measuring the -3 dB frequency response**

With  $f_i = 1$  MHz adjust the switch input voltage for a 0 dBm level at the switch output, (0 dBm = 1 mW into 50  $\Omega$ ). Then increase the input frequency until the dB meter reads -3 dB.



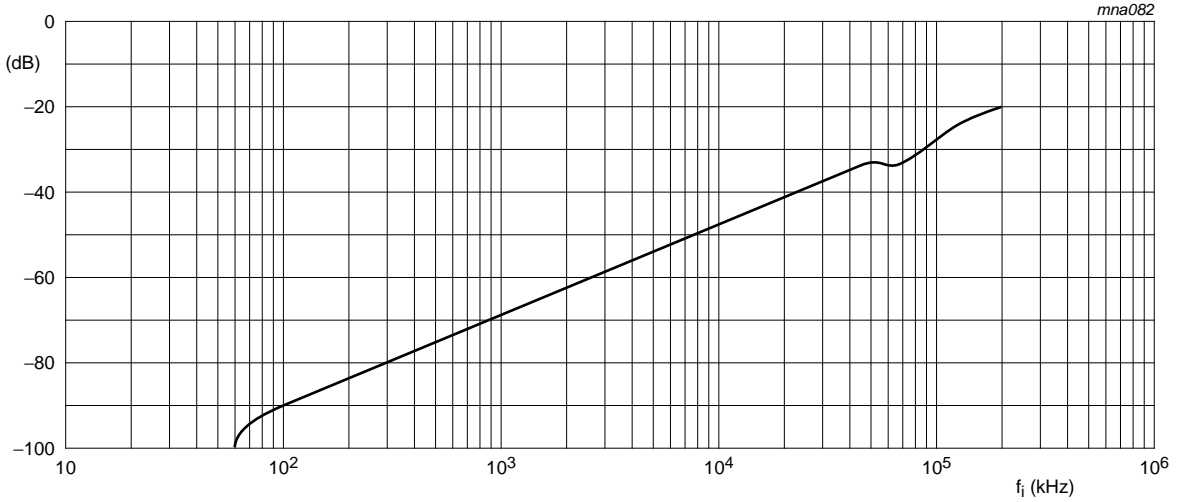
Test conditions:  $V_{CC} = 4.5\text{ V}$ ;  $GND = 0\text{ V}$ ;  $R_L = 50\ \Omega$ ;  $R_{SOURCE} = 1\text{ k}\Omega$ .

**Fig 15. Typical -3 dB frequency response**



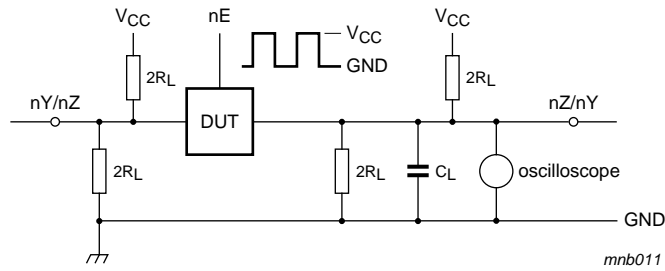
Adjust the switch input voltage for a 0 dBm level (0 dBm = 1 mW into 600  $\Omega$ )

**Fig 16. Test circuit for measuring isolation (OFF-state)**

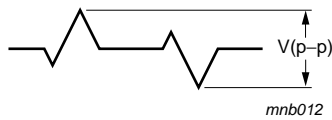


Test conditions:  $V_{CC} = 4.5\text{ V}$ ;  $GND = 0\text{ V}$ ;  $R_L = 50\ \Omega$ ;  $R_{SOURCE} = 1\text{ k}\Omega$ .

Fig 17. Typical isolation (OFF-state) as a function of frequency



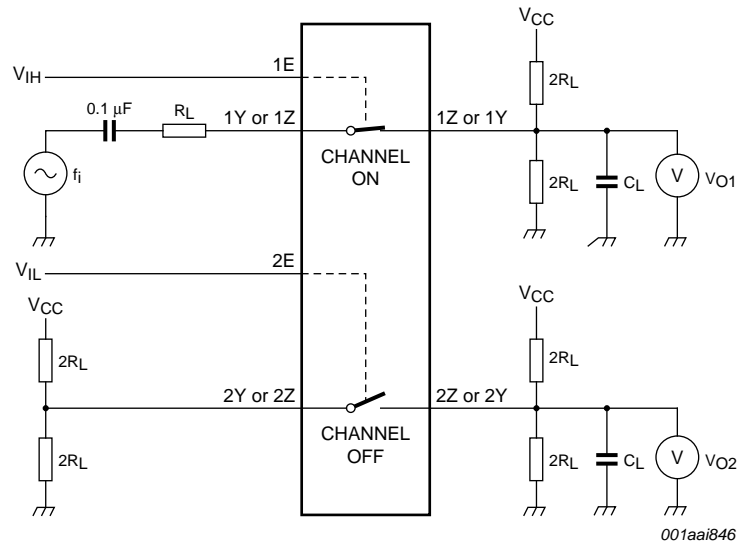
a. Circuit



b. Crosstalk voltage

Adjust the switch input voltage for a 0 dBm level (0 dBm = 1 mW into 600  $\Omega$ )

Fig 18. Test circuit for measuring crosstalk voltage (between the digital input and the switch)



Adjust the switch input voltage for a 0 dBm level (0 dBm = 1 mW into 600 Ω)

**Fig 19. Test circuit for measuring crosstalk (between the switches)**



12. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2

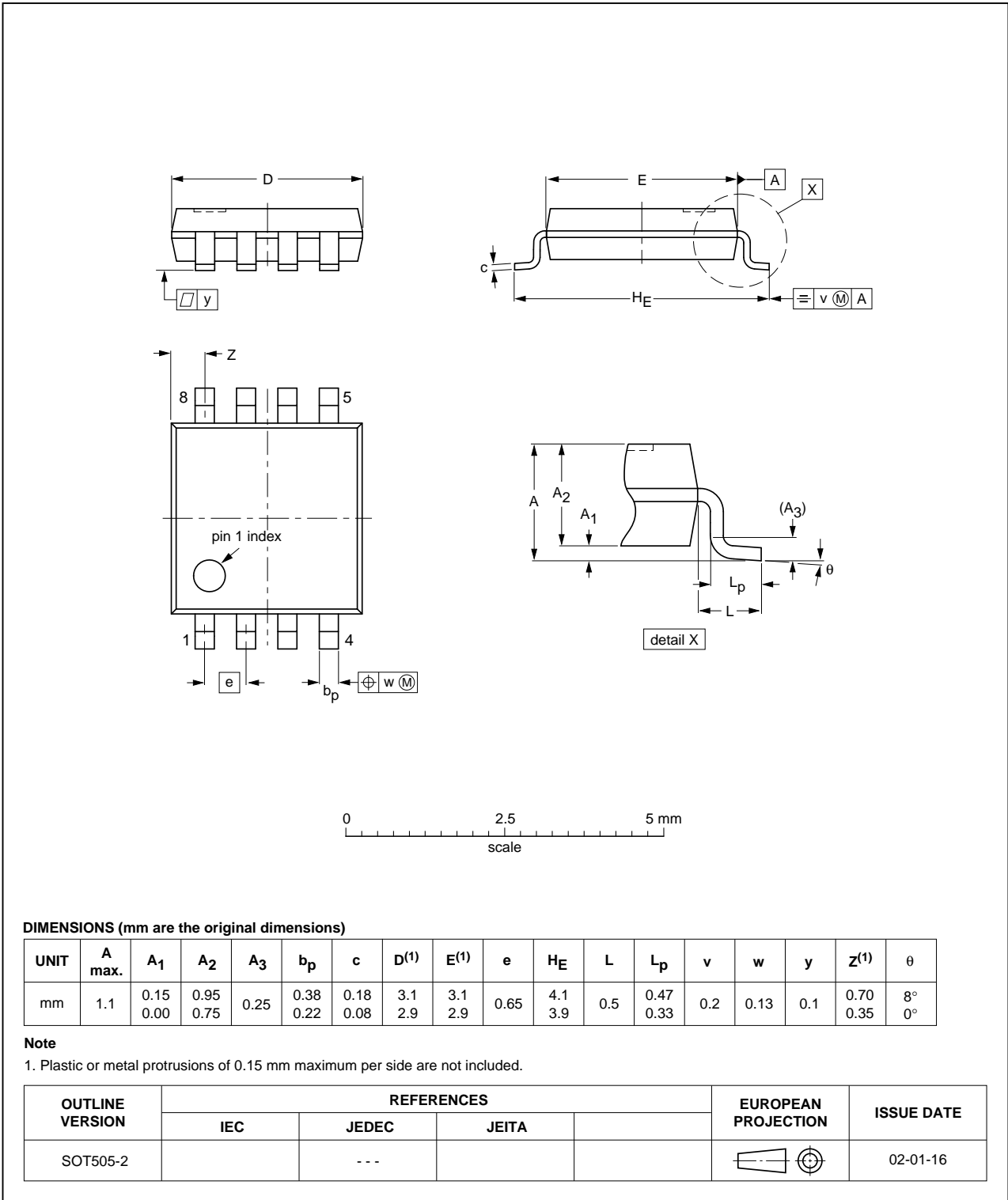


Fig 20. Package outline SOT505-2 (TSSOP8)

VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1

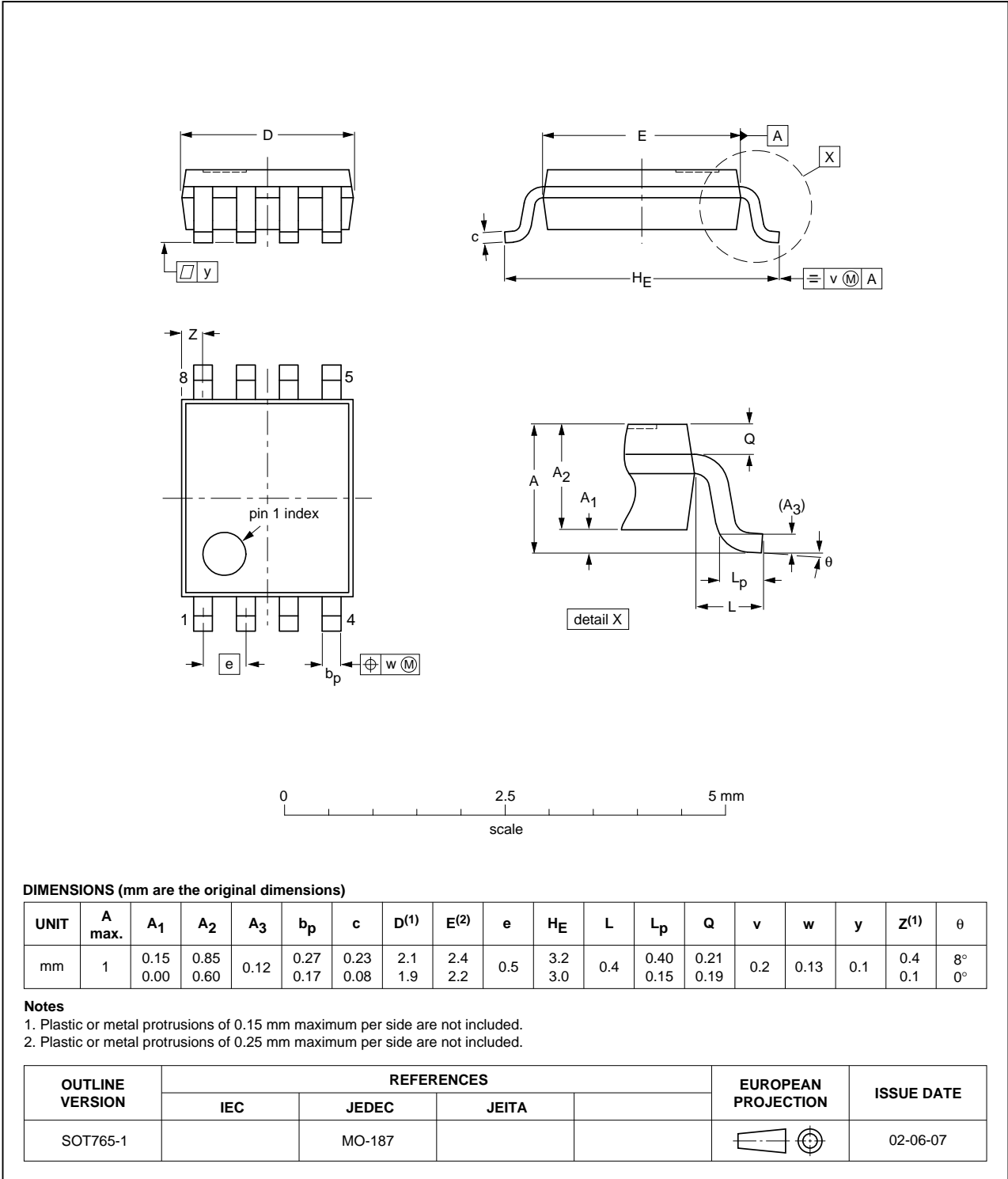


Fig 21. Package outline SOT765-1 (VSSOP8)

XSON8: plastic extremely thin small outline package; no leads; 8 terminals; body 1 x 1.95 x 0.5 mm

SOT833-1

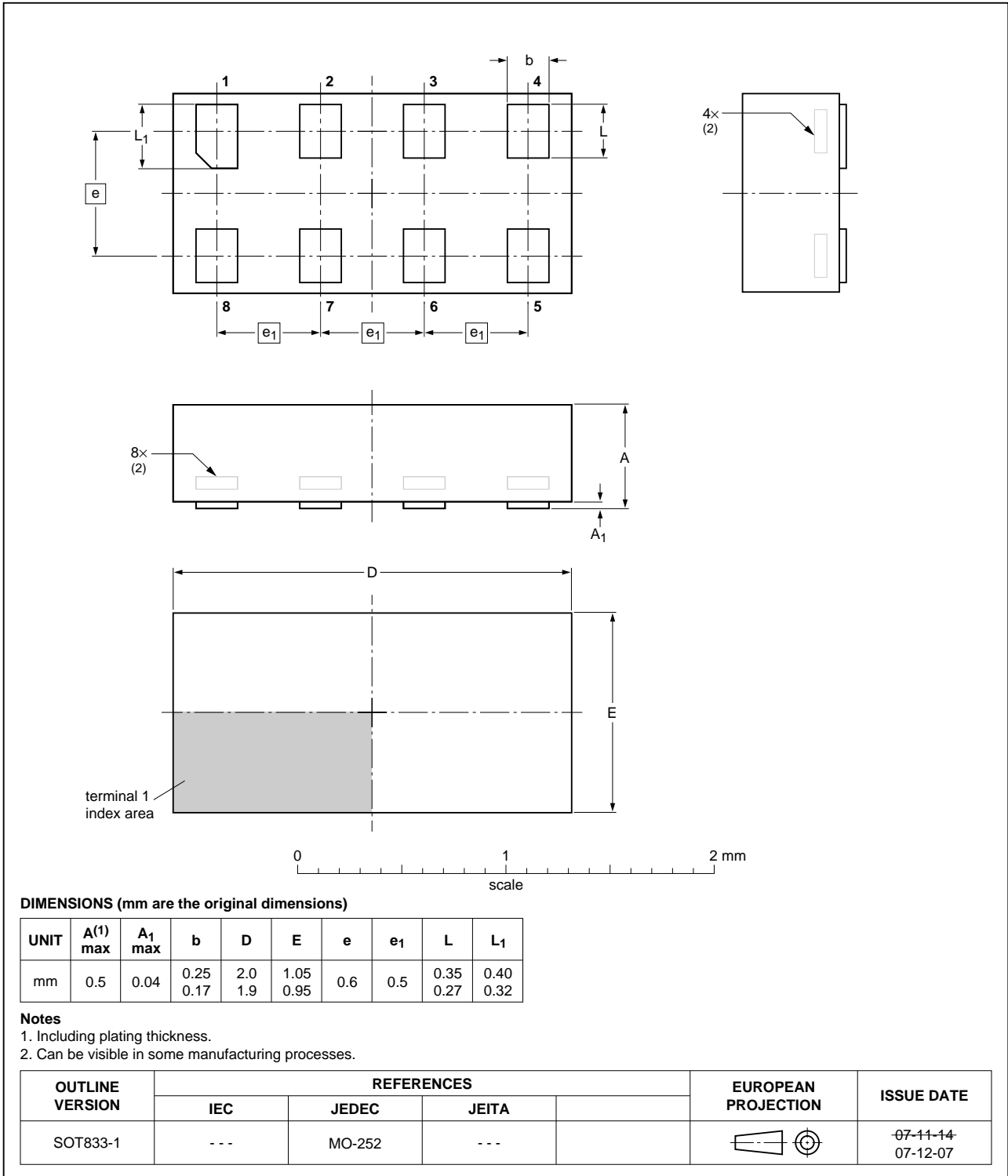


Fig 22. Package outline SOT833-1 (XSON8)

XSON8: plastic extremely thin small outline package; no leads;  
8 terminals; body 3 x 2 x 0.5 mm

SOT996-2

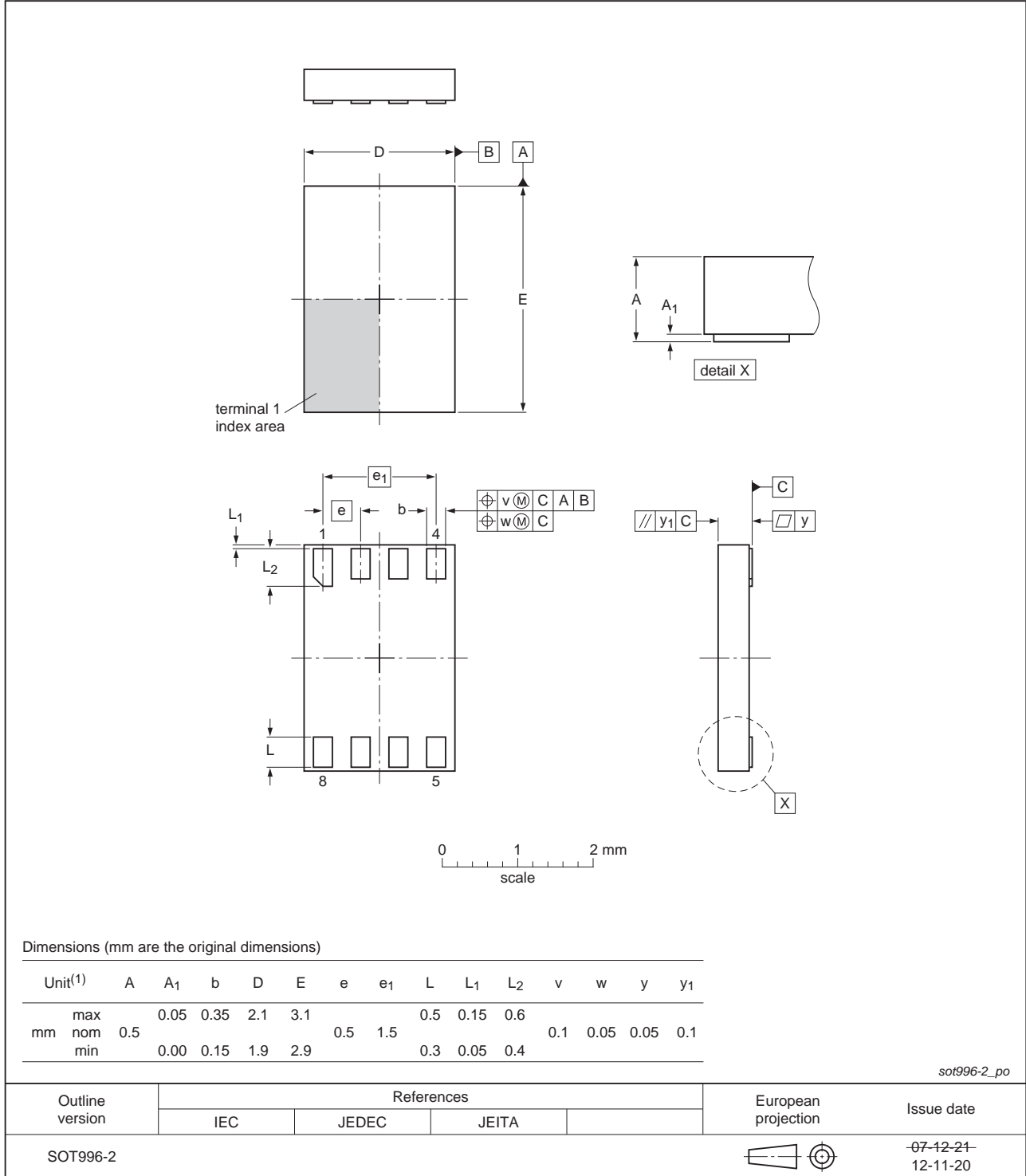


Fig 23. Package outline SOT996-2 (XSON8)

## 13. Abbreviations

Table 13. Abbreviations

| Acronym | Description                             |
|---------|---|
| CMOS    | Complementary Metal-Oxide Semiconductor |
| ESD     | ElectroStatic Discharge                 |
| HBM     | Human Body Model                        |
| MM      | Machine Model                           |
| DUT     | Device Under Test                       |

## 14. Revision history

Table 14. Revision history

| Document ID       | Release date   | Data sheet status     | Change notice | Supersedes       |
|-------------------|--|-----------------------|---------------|------------------|
| 74HC_HCT2G66 v.10 | 20131003   | Product data sheet    | -             | 74HC_HCT2G66 v.9 |
| Modifications:    | <ul style="list-style-type: none"> <li>For type numbers 74HC2G66GD and 74HCT2G66GD XSON8U has changed to XSON8.</li> </ul> |                       |               |                  |
| 74HC_HCT2G66 v.9  | 20111213   | Product data sheet    | -             | 74HC_HCT2G66 v.8 |
| 74HC_HCT2G66 v.8  | 20100923   | Product data sheet    | -             | 74HC_HCT2G66 v.7 |
| 74HC_HCT2G66 v.7  | 20100914   | Product data sheet    | -             | 74HC_HCT2G66 v.6 |
| 74HC_HCT2G66 v.6  | 20100402   | Product data sheet    | -             | 74HC_HCT2G66 v.5 |
| 74HC_HCT2G66 v.5  | 20090126   | Product data sheet    | -             | 74HC_HCT2G66 v.4 |
| 74HC_HCT2G66 v.4  | 20040519   | Product specification | -             | 74HC_HCT2G66 v.3 |
| 74HC_HCT2G66 v.3  | 20031126   | Product specification | -             | 74HC_HCT2G66 v.2 |
| 74HC_HCT2G66 v.2  | 20030808   | Product specification | -             | 74HC_HCT2G66 v.1 |
| 74HC_HCT2G66 v.1  | 20030625   | Product specification | -             | -                |

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### 15.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
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| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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 Date of release: 3 October 2013  
 Document identifier: 74HC\_HCT2G66